



Antenna Datasheet

Product OC (Antenna Only): YC0017DA

Product OC (Antenna + Rectangular EVB): YC0017DAEVB

Version: 3.0

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Status: Released

Product Name: 4G SMD Antenna

Key Features:

Frequency band: 698–960 MHz, 1710–2690 MHz, 3300–3800 MHz

Efficiency: Up to 70.7 % (On 140 × 36 mm EVB)

Dimensions: 25 mm × 7 mm × 3 mm

RoHS & REACH Compliant

Overview

This Quectel embedded 4G SMD antenna covers main 4G LTE bands and is compatible with 3G/2G/LPWA bands. Featuring high efficiency and gain, it is an ideal antenna for a smooth and stable connection with high-efficiency data transmission even under the influence of the device's internal structure. Ground plane dependent, it's designed to be mounted directly to the device host PCB using a conventional PCB reflow process. Supplied tape and reel for high volume pick and place assembly, this SMD antenna can be tuned specifically for the final device environment with a simple PI matching circuit.

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1 Specification

Test Condition: Assembled On EVB

1.1. Electrical

Electrical	
Frequency Range	698–960 MHz, 1710–2690 MHz, 3300–3800 MHz
Impedance	50 Ω
Polarization	Linear
Radiation Pattern	Omni-directional

Electrical - Detail									
Band	Band	B71	B12 /B13 /B28	B5 /B8 /B26	B1 /B2 /B3	B40	Wi-Fi 2G	B38 /B41	B42 /B48 /B78
SPEC	Freq. (MHz)	600– 698	700– 810	820– 960	1710– 2170	2300– 2400	2400– 2500	2500– 2690	3300– 3800
Max VSWR	On 140 × 36 mm EVB	-	3.1	3.5	3.2	4.5	4.5	4.5	3.9
	On 130 × 36 mm EVB	-	3.4	3.6	2.7	4.1	4.1	4.9	4.0
	On 110 × 36 mm EVB	-	4.1	4.7	3.5	3.3	3.3	4.5	4.0
	On 90 × 36 mm EVB	-	4.6	6.4	4.0	4.4	4.2	4.2	3.9
	On 60 × 36 mm EVB	-	4.8	5.9	2.5	3.4	3.5	4.7	3.9
	On 40 × 36 mm EVB	-	4.5	4.5	4.2	3.9	3.6	3.9	3.9
Max	On 140 × 36 mm EVB	-	-5.9	-5.1	-5.7	-3.9	-3.9	-3.9	-4.6

Return Loss (dB)	On 130 × 36 mm EVB	-	-5.3	-5.0	-6.9	-4.3	-4.3	-3.6	-4.4
	On 110 × 36 mm EVB	-	-4.3	-3.7	-5.1	-5.4	-5.5	-3.9	-4.5
	On 90 × 36 mm EVB	-	-3.8	-2.7	-4.4	-4.0	-4.3	-4.2	-4.5
	On 60 × 36 mm EVB	-	-3.7	-3.0	-7.3	-5.2	-5.1	-3.8	-4.6
	On 40 × 36 mm EVB	-	-3.9	-3.9	-4.2	-4.6	-5.0	-4.5	-4.6
AVG Eff. (%)	On 140 × 36 mm EVB	-	51.2	50.2	65.0	41.6	47.9	46.9	51.9
	On 130 × 36 mm EVB	-	45.0	50.0	60.5	45.0	48.6	44.6	52.1
	On 110 × 36 mm EVB	-	30.6	40.8	51.5	49.8	57.9	48.9	52.3
	On 90 × 36 mm EVB	-	19.5	26.5	55.8	38.7	48.2	46.9	51.5
	On 60 × 36 mm EVB	-	15.0	19.2	68.6	52.0	56.3	46.4	52.0
	On 40 × 36 mm EVB	-	16.9	21.8	48.9	46.8	58.2	51.1	51.3
AVG AVG Gain (dB)	On 140 × 36 mm EVB	-	-3.1	-3.0	-1.9	-3.8	-3.2	-3.4	-2.9
	On 130 × 36 mm EVB	-	-3.7	-3.0	-2.2	-3.5	-3.1	-3.6	-2.9
	On 110 × 36 mm EVB	-	-5.4	-3.9	-2.9	-3.0	-2.4	-3.2	-2.9
	On 90 × 36 mm EVB	-	-7.3	-5.8	-2.6	-4.1	-3.2	-3.4	-2.9
	On 60 × 36 mm EVB	-	-8.4	-7.2	-1.6	-2.8	-2.5	-3.4	-2.9
	On 40 × 36 mm EVB	-	-7.8	-6.7	-3.1	-3.3	-2.4	-3.0	-3.0
Max Peak Gain (dBi)	On 140 × 36 mm EVB	-	1.8	1.7	2.7	1.3	1.9	1.9	3.1
	On 130 × 36 mm EVB	-	1.6	1.6	2.5	1.5	2.1	2.1	3.6
	On 110 × 36 mm EVB	-	0.4	0.5	3.6	0.8	1.1	1.3	4.1
	On 90 × 36 mm EVB	-	-1.7	-1.2	3.4	-0.5	0.1	0.5	4.0
	On 60 × 36 mm EVB	-	-1.7	-0.7	2.3	-0.4	-0.1	0.8	4.0
	On 40 × 36 mm EVB	-	-1.0	0.3	4.2	0.0	0.9	1.6	4.4
VSWR		On 140 × 36 mm EVB		≤ 4.5					
		On 130 × 36 mm EVB		≤ 4.9					
		On 110 × 36 mm EVB		≤ 4.7					

	On 90 × 36 mm EVB	≤ 6.4
	On 60 × 36 mm EVB	≤ 5.9
	On 40 × 36 mm EVB	≤ 4.5
Return Loss	On 140 × 36 mm EVB	≤-3.9 dB
	On 130 × 36 mm EVB	≤-3.6 dB
	On 110 × 36 mm EVB	≤-3.9 dB
	On 90 × 36 mm EVB	≤-2.7 dB
	On 60 × 36 mm EVB	≤-3.0 dB
	On 40 × 36 mm EVB	≤-3.9 dB
Peak Gain	On 140 × 36 mm EVB	≤ 3.1 dBi
	On 130 × 36 mm EVB	≤ 3.6 dBi
	On 110 × 36 mm EVB	≤ 4.1 dBi
	On 90 × 36 mm EVB	≤ 4 dBi
	On 60 × 36 mm EVB	≤ 4 dBi
	On 40 × 36 mm EVB	≤ 4.4 dBi

1.2. Supported Bands

5G NR / LTE / LTE-Advanced / WCDMA / HSPA / HSPA+ / GPRS / GSM / NB-IoT				
Band	Frequency (MHz)	Uplink (MHz)	Downlink (MHz)	Covered
1	2100	1920–1980	2110–2170	√
2	1900	1850–1910	1930–1990	√
3	1800	1710–1785	1805–1880	√
4	1700	1710–1755	2110–2155	√
5	850	824–849	869–894	√
7	2600	2500–2570	2620–2690	√

8	900	880–915	925–960	√
9	1800	1749.9–1784.9	1844.9–1879.9	√
11	1500	1427.9–1447.9	1475.9–1495.9	-
12	700	699–716	729–746	√
13	700	777–787	746–756	√
14	700	788–798	758–768	√
17	700	704–716	734–746	√
18	850	815–830	860–875	√
19	850	830–845	875–890	√
20	800	832–862	791–821	√
21	1500	1447.9–1462.9	1495.9–1510.9	-
22	3500	3410–3490	3510–3590	√
23	2100	2000–2020	2180–2200	√
24	1600	1626.5–1660.5	1525–1559	-
25	1900	1850–1915	1930–1995	√
26	850	814–849	859–894	√
28	700	703–748	758–803	√
31	450	452.5–457.5	462.5–467.5	-
34	2100	2010–2025		√
38	2600	2570–2620		√
39	1900	1880–1920		√
40	2300	2300–2400		√
41	2500	2496–2690		√
42	3500	3400–3600		√
48	3500	3550–3700		√
66	1700	1710–1780	2110–2200	√

71	600	663–698	617–652	-
74	1500	1427–1470	1475–1518	-
77	3500	3300–4200		√
78	3500	3300–3800		√
79	4500	4400–5000		-

Note:

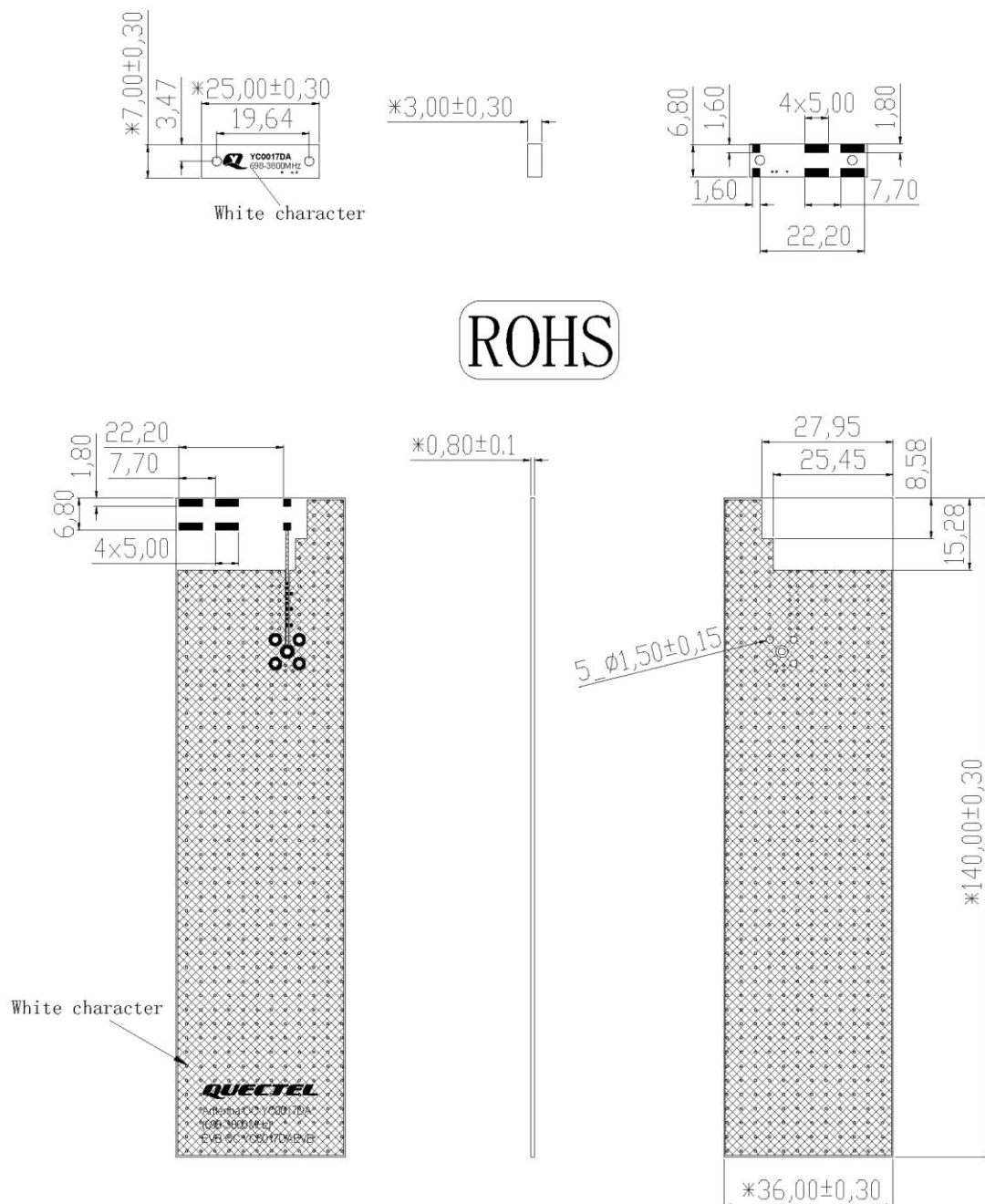
- Covered √ means efficiency > 10 %.
- Based on 140 × 36 mm EVB

1.3. Mechanical & Environmental

Mechanical	
Antenna Size	25 × 7 × 3 mm
Material & Color	FR4 & Black
Antenna Weight	Typ. 1.05 g
Mounting Type	SMD
Recommended EVB Size	140 × 36 × 0.8 mm
Environmental	
Operation Temperature	-40 °C to +85 °C
Storage Temperature	-40 °C to 85 °C
RoHS & REACH Compliant	Yes

2 Drawing

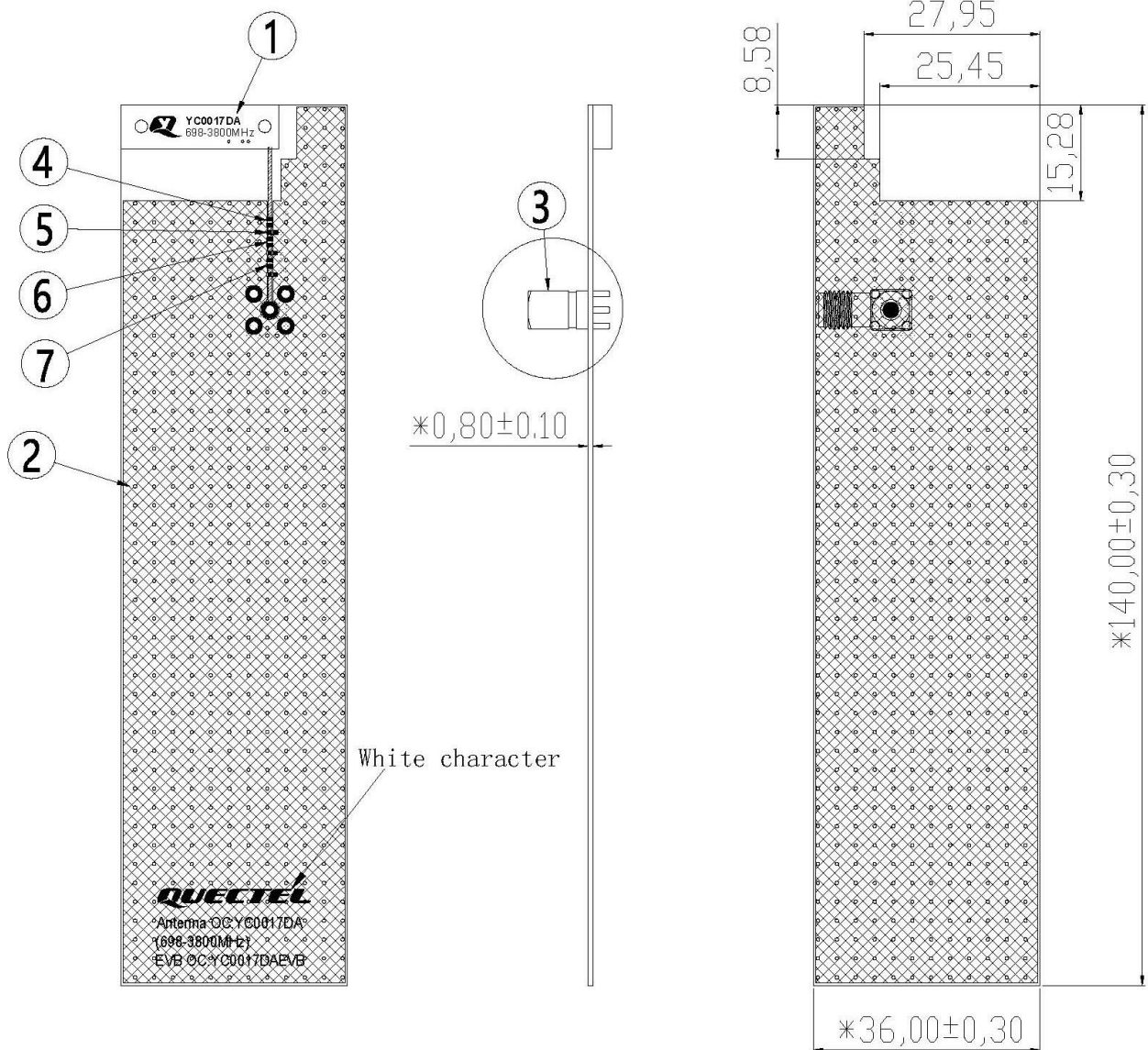
2.1. Antenna



All dimensions are in mm.

Name	Material	Brand	QTY	Model
Antenna	FR4 3.0t	Quectel	1	YC0017DA
PCB	FR4 0.8t	Quectel	1	YC0017DAEVB
0 Ω	Ceramics	Murata	1	-
10nH	Ceramics	Murata	1	LQG15HS10NJ02
2.4pF	Ceramics	Murata	1	GCM1555C1H2R4BA16
1.5nH	Ceramics	Murata	1	LQG15HS1N5S02
SMA Female Connector	Brass	Quectel	1	-

2.2. Rectangular EVB

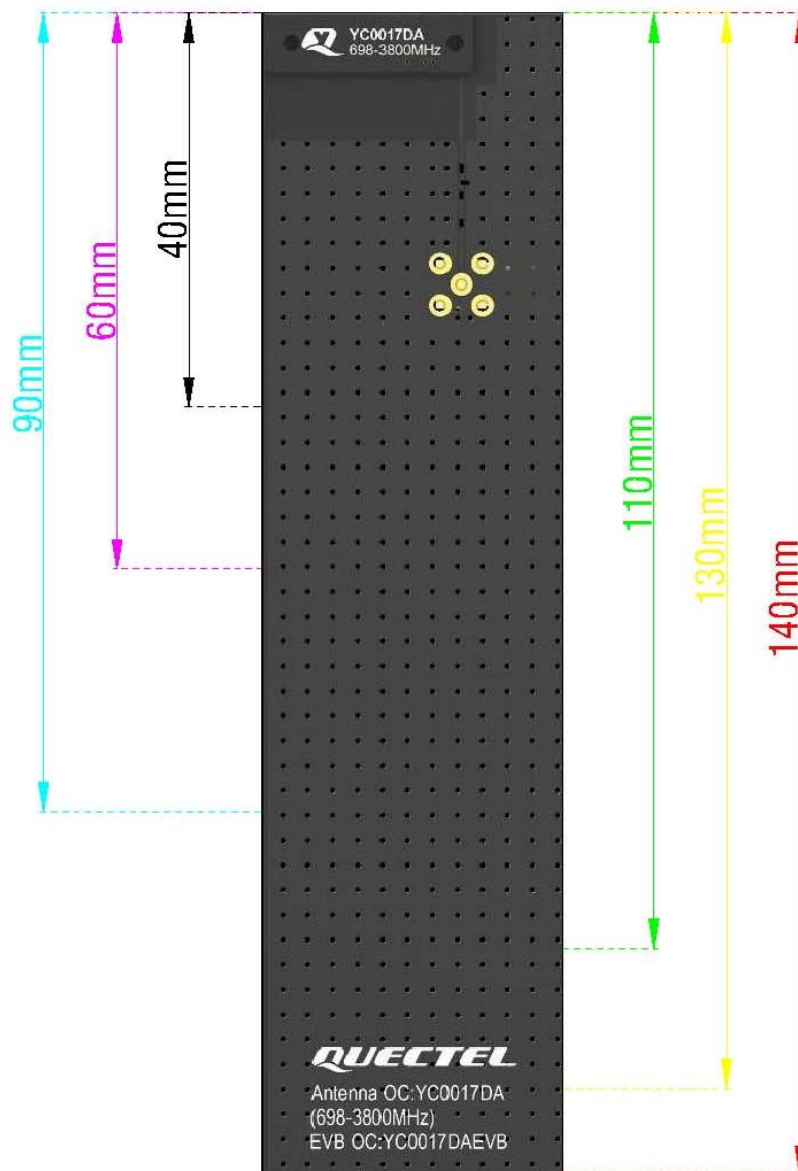


All dimensions are in mm.

3 Detailed Performance

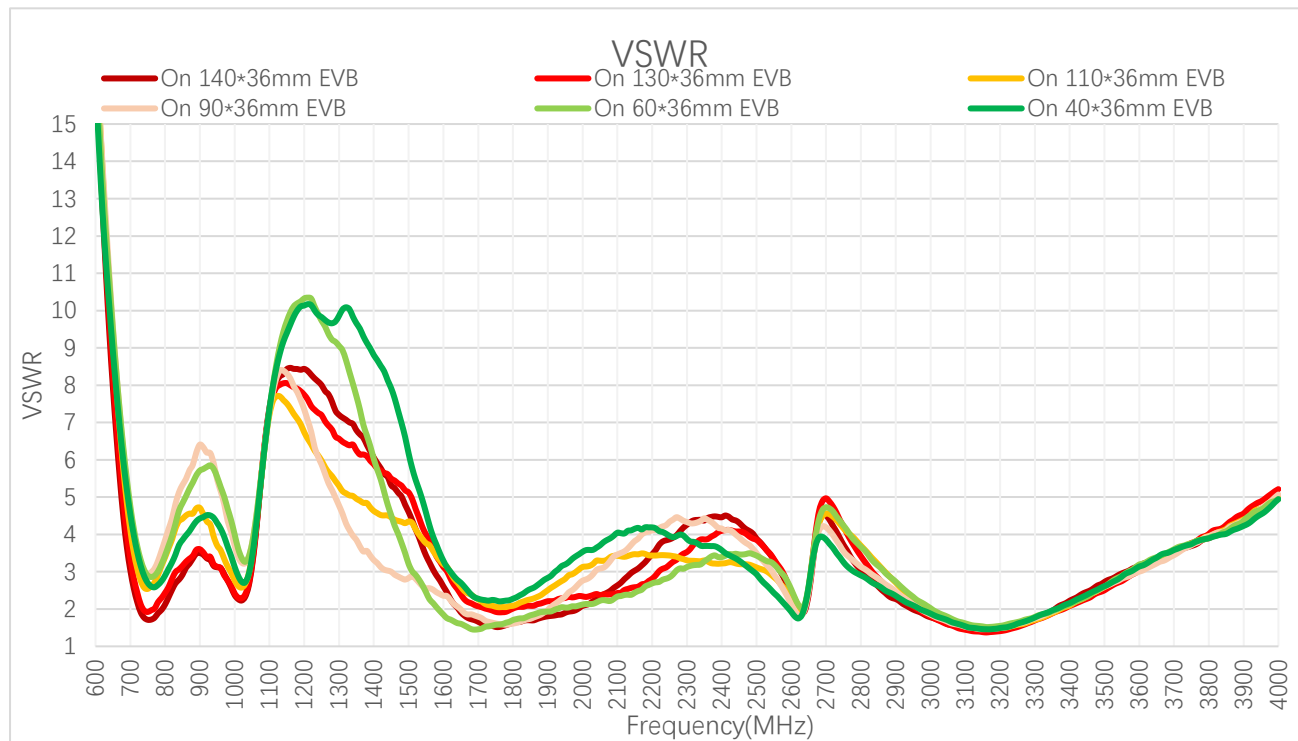
3.1. GND Length Dimensions Overview

The performance of the low bands is highly dependent on the ground plane length. The host PCB ground needs to be as long as the device allows. Reducing the GND directly relates to the performance of the low bands. As shown below you can see the effect of the different shapes vs the efficiency.



3.2. S-Parameter Test

3.2.1. VSWR

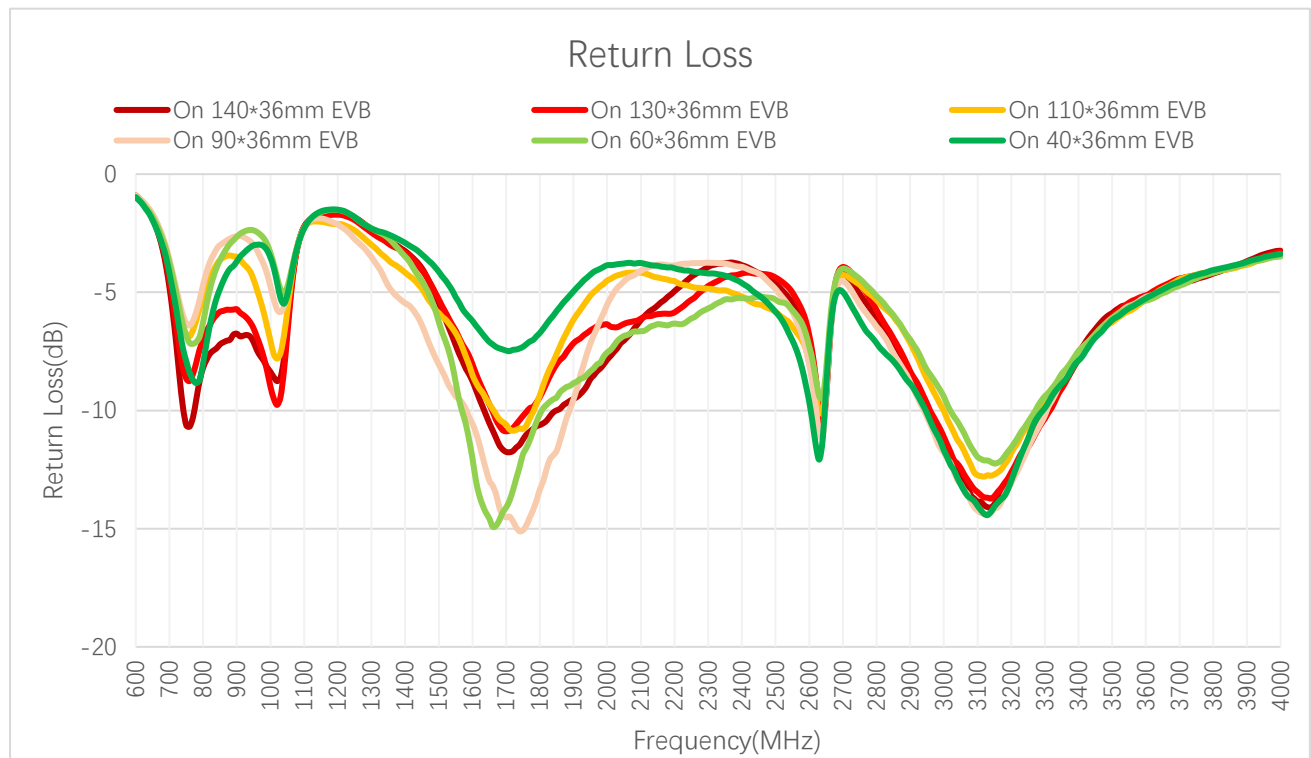


VSWR

Frequency (MHz)	600	630	710	830	900	960	1440	1710	1740	1880
On 140 × 36 mm EVB	-	-	2.6	2.7	3.5	3.1	-	1.6	1.6	1.8
On 130 × 36 mm EVB	-	-	2.8	3.0	3.6	3.1	-	2.0	2.0	2.1
On 110 × 36 mm EVB	-	-	3.5	4.2	4.7	3.6	-	2.2	2.1	2.4
On 90 × 36 mm EVB	-	-	4.0	4.8	6.4	5.2	-	1.8	1.6	1.9
On 60 × 36 mm EVB	-	-	4.2	4.3	5.7	5.3	-	1.5	1.6	1.9
On 40 × 36 mm EVB	-	-	4.0	3.5	4.4	4.2	-	2.3	2.2	2.7
Frequency (MHz)	1950	2140	2350	2450	2600	2690	3300	3800	5500	6000
On 140 × 36 mm EVB	1.9	3.0	4.4	4.3	2.4	4.5	1.7	3.9	-	-

On 130 × 36 mm EVB	2.3	2.6	3.9	4.1	2.5	4.9	1.7	4.0	-	-
On 110 × 36 mm EVB	2.8	3.5	3.3	3.2	2.3	4.5	1.7	4.0	-	-
On 90 × 36 mm EVB	2.3	3.7	4.4	3.9	2.1	4.2	1.7	3.9	-	-
On 60 × 36 mm EVB	2.0	2.4	3.3	3.5	2.5	4.7	1.8	3.9	-	-
On 40 × 36 mm EVB	3.2	4.1	3.7	3.3	1.9	3.9	1.8	3.9	-	-

3.2.2. Return Loss

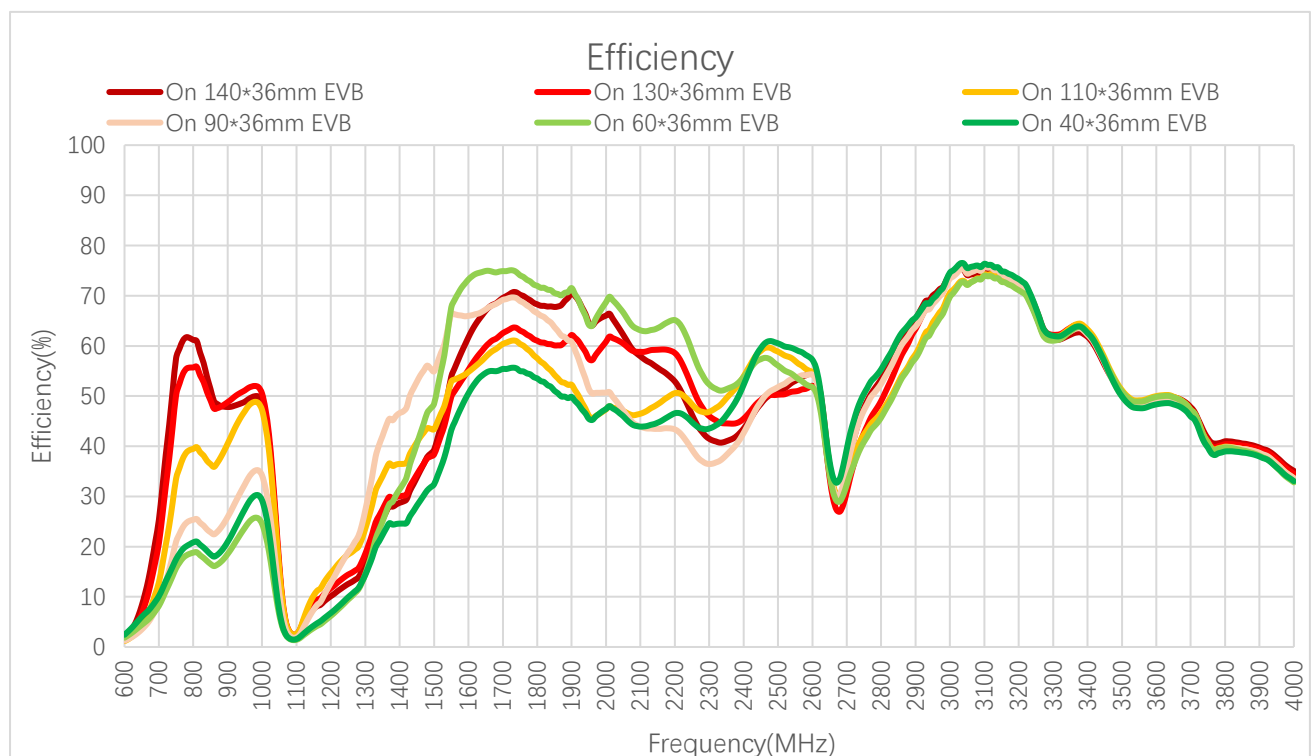


Return Loss (dB)										
Frequency (MHz)	600	630	710	830	900	960	1440	1710	1740	1880
On 140 × 36 mm EVB	-	-	-7.2	-6.8	-5.1	-5.8	-	-12.6	-13.3	-11.2
On 130 × 36 mm EVB	-	-	-6.4	-6.0	-5.0	-5.8	-	-9.3	-9.8	-8.8
On 110 × 36 mm EVB	-	-	-5.1	-4.3	-3.7	-5.0	-	-8.5	-9.0	-7.8
On 90 × 36 mm	-	-	-4.4	-3.7	-2.7	-3.4	-	-11.2	-12.3	-10.5

EVB										
On 60 × 36 mm EVB	-	-	-4.3	-4.1	-3.1	-3.3	-	-14.3	-13.3	-10.0
On 40 × 36 mm EVB	-	-	-4.5	-5.2	-4.0	-4.3	-	-8.3	-8.3	-6.7
Frequency (MHz)	1950	2140	2350	2450	2600	2690	3300	3800	5500	6000
On 140 × 36 mm EVB	-10.2	-6.1	-4.0	-4.1	-7.8	-3.9	-11.5	-4.6	-	-
On 130 × 36 mm EVB	-8.1	-7.1	-4.6	-4.3	-7.5	-3.6	-11.8	-4.4	-	-
On 110 × 36 mm EVB	-6.5	-5.2	-5.4	-5.6	-8.0	-3.9	-11.6	-4.5	-	-
On 90 × 36 mm EVB	-7.9	-4.8	-4.0	-4.5	-8.8	-4.2	-11.3	-4.5	-	-
On 60 × 36 mm EVB	-9.3	-7.8	-5.5	-5.2	-7.3	-3.8	-11.0	-4.6	-	-
On 40 × 36 mm EVB	-5.6	-4.3	-4.8	-5.4	-10.0	-4.5	-11.1	-4.6	-	-

3.3. Radiation Performance Test

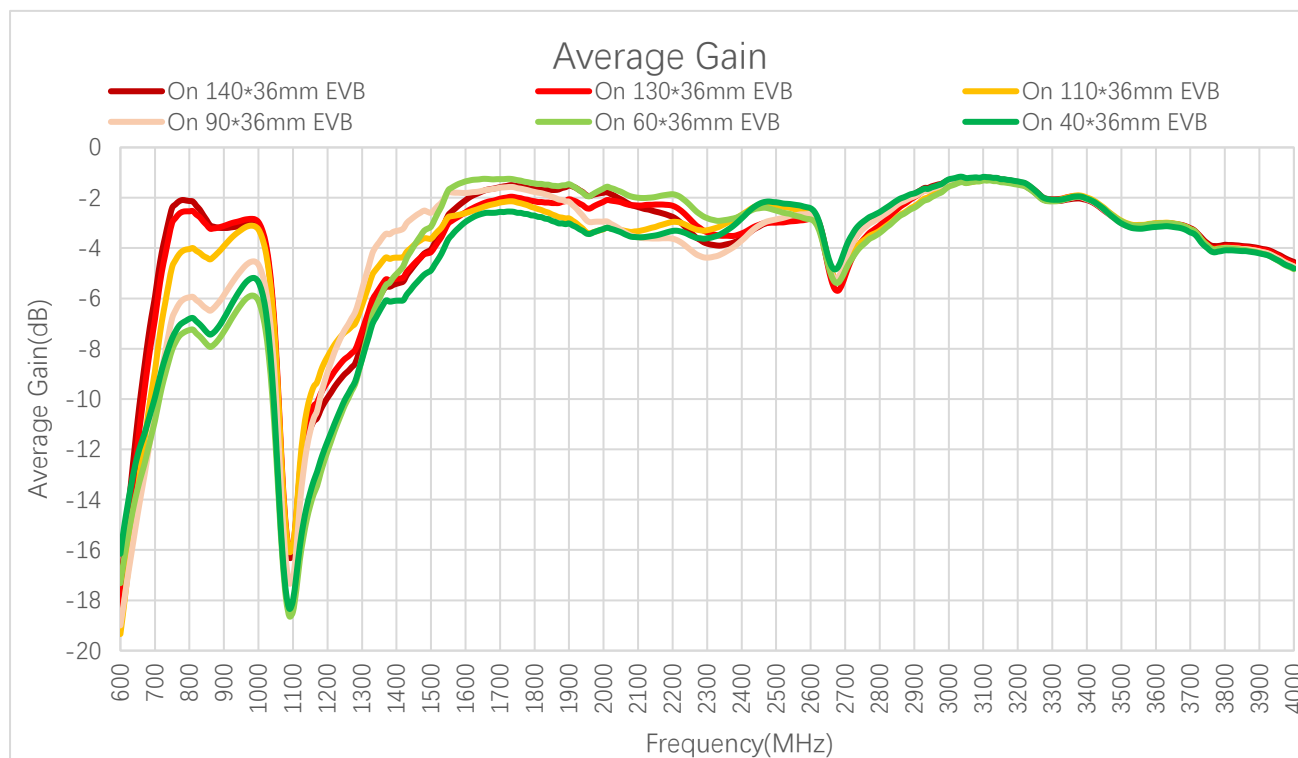
3.3.1. Efficiency



Efficiency (%)

Frequency (MHz)	600	630	710	830	900	960	1440	1710	1740	1880
On 140 × 36 mm EVB	-	-	31.7	56.6	47.8	49.4	-	69.9	70.7	69.0
On 130 × 36 mm EVB	-	-	26.2	52.8	48.8	51.6	-	62.9	63.6	60.8
On 110 × 36 mm EVB	-	-	16.4	38.1	40.5	48.0	-	60.6	60.9	52.6
On 90 × 36 mm EVB	-	-	10.7	24.2	25.9	33.7	-	69.3	69.5	61.8
On 60 × 36 mm EVB	-	-	9.6	17.8	18.5	24.7	-	74.9	74.7	70.6
On 40 × 36 mm EVB	-	-	11.5	19.8	21.0	28.7	-	55.4	55.5	49.9
Frequency (MHz)	1950	2140	2350	2450	2600	2690	3300	3800	5500	6000
On 140 × 36 mm EVB	64.6	56.1	41.0	48.4	54.8	32.0	61.2	41.0	-	-
On 130 × 36 mm EVB	57.4	59.2	44.6	49.2	52.0	28.4	62.2	40.4	-	-
On 110 × 36 mm EVB	46.1	47.9	49.6	59.0	54.8	31.7	61.8	39.9	-	-
On 90 × 36 mm EVB	51.5	43.5	38.2	48.9	54.3	32.5	61.8	39.8	-	-
On 60 × 36 mm EVB	64.2	63.3	51.4	57.3	51.8	30.3	61.0	39.8	-	-
On 40 × 36 mm EVB	45.5	44.4	46.2	59.5	57.2	36.2	62.0	39.0	-	-

3.3.2. Average Gain

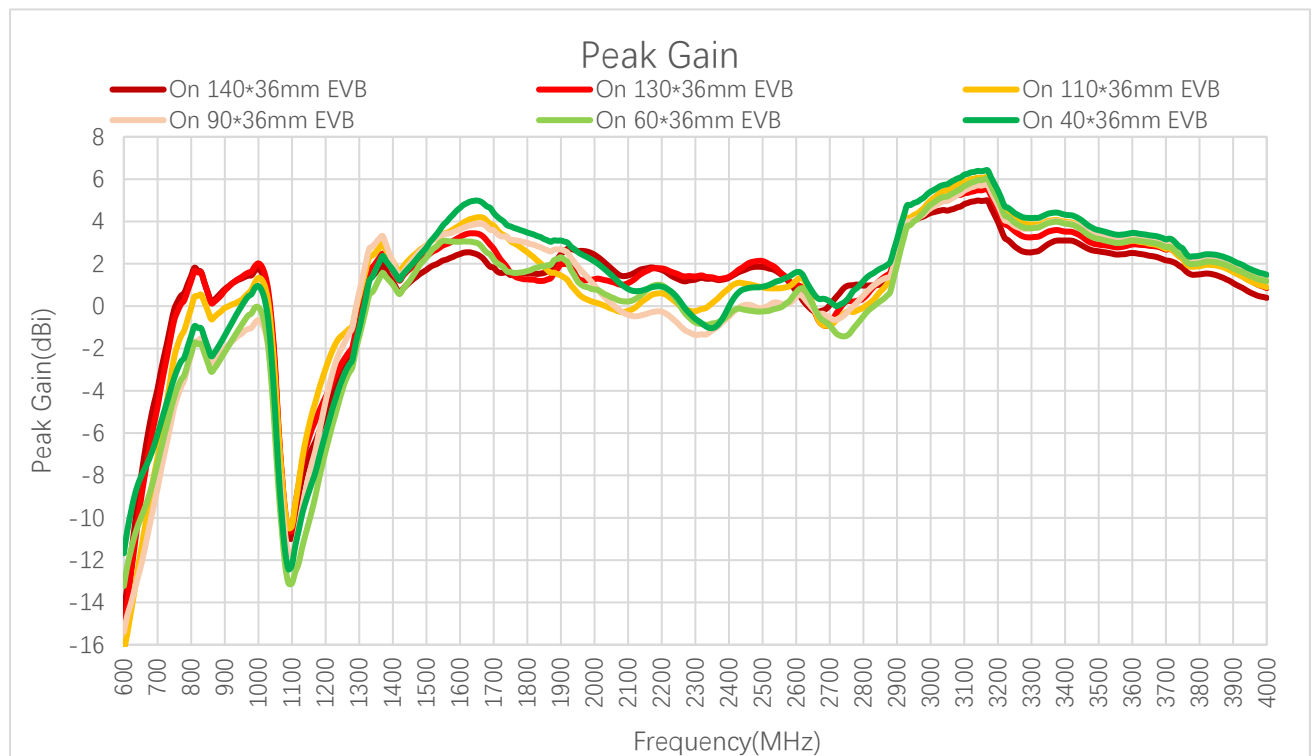


Average Gain (dB)

Frequency (MHz)	600	630	710	830	900	960	1440	1710	1740	1880
On 140 × 36 mm EVB	-	-	-5.0	-2.5	-3.2	-3.1	-	-1.6	-1.5	-1.6
On 130 × 36 mm EVB	-	-	-5.8	-2.8	-3.1	-2.9	-	-2.0	-2.0	-2.2
On 110 × 36 mm EVB	-	-	-7.9	-4.2	-3.9	-3.2	-	-2.2	-2.2	-2.8
On 90 × 36 mm EVB	-	-	-9.7	-6.2	-5.9	-4.7	-	-1.6	-1.6	-2.1
On 60 × 36 mm EVB	-	-	-10.2	-7.5	-7.3	-6.1	-	-1.3	-1.3	-1.5
On 40 × 36 mm EVB	-	-	-9.4	-7.0	-6.8	-5.4	-	-2.6	-2.6	-3.0
Frequency (MHz)	1950	2140	2350	2450	2600	2690	3300	3800	5500	6000
On 140 × 36 mm EVB	-1.9	-2.5	-3.9	-3.2	-2.6	-4.9	-2.1	-3.9	-	-
On 130 × 36 mm EVB	-2.4	-2.3	-3.5	-3.1	-2.8	-5.5	-2.1	-3.9	-	-

On 110 × 36 mm EVB	-3.4	-3.2	-3.1	-2.3	-2.6	-5.0	-2.1	-4.0	-	-
On 90 × 36 mm EVB	-2.9	-3.6	-4.2	-3.1	-2.7	-4.9	-2.1	-4.0	-	-
On 60 × 36 mm EVB	-1.9	-2.0	-2.9	-2.4	-2.9	-5.2	-2.1	-4.0	-	-
On 40 × 36 mm EVB	-3.4	-3.5	-3.4	-2.3	-2.4	-4.4	-2.1	-4.1	-	-

3.3.3. Peak Gain



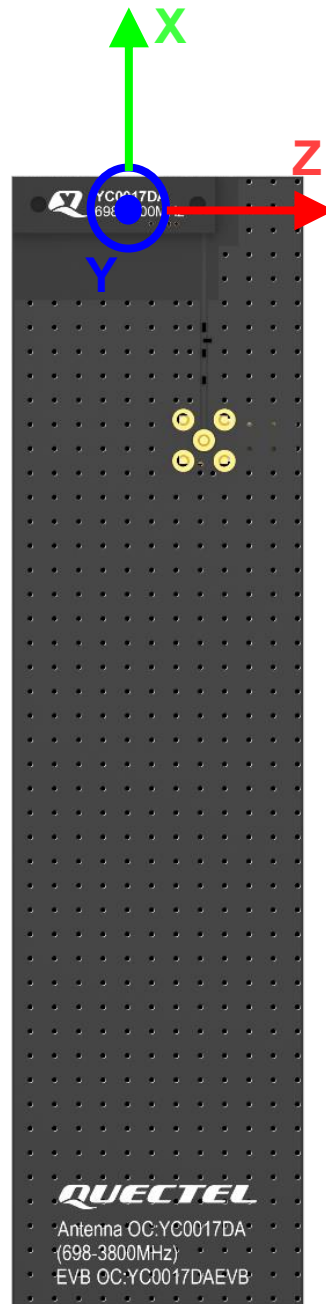
Peak Gain (dBi)

Frequency (MHz)	600	630	710	830	900	960	1440	1710	1740	1880
On 140 × 36 mm EVB	-	-	-3.1	1.6	0.8	1.4	-	1.7	1.6	2.0
On 130 × 36 mm EVB	-	-	-3.9	1.6	0.7	1.5	-	2.5	1.8	1.6
On 110 × 36 mm EVB	-	-	-6.2	0.5	-0.1	0.5	-	3.6	3.3	1.6
On 90 × 36 mm EVB	-	-	-7.8	-1.5	-2.0	-1.2	-	3.4	3.3	2.7

On 60 × 36 mm EVB	-	-	-6.8	-1.8	-2.2	-0.7	-	2.0	1.6	2.2
On 40 × 36 mm EVB	-	-	-5.5	-1.1	-1.4	0.3	-	4.2	3.8	3.1
Frequency (MHz)	1950	2140	2350	2450	2600	2690	3300	3800	5500	6000
On 140 × 36 mm EVB	2.6	1.7	1.3	1.7	0.7	-0.1	2.5	1.5	-	-
On 130 × 36 mm EVB	1.3	1.5	1.4	1.9	1.0	-0.9	3.3	1.9	-	-
On 110 × 36 mm EVB	0.6	0.2	0.1	1.1	1.2	-0.9	3.9	1.9	-	-
On 90 × 36 mm EVB	1.9	-0.4	-1.2	0.1	0.4	-0.5	3.7	2.3	-	-
On 60 × 36 mm EVB	1.2	0.6	-0.8	-0.2	0.7	-0.8	3.7	2.0	-	-
On 40 × 36 mm EVB	2.6	0.7	-1.0	0.8	1.6	0.3	4.2	2.4	-	-

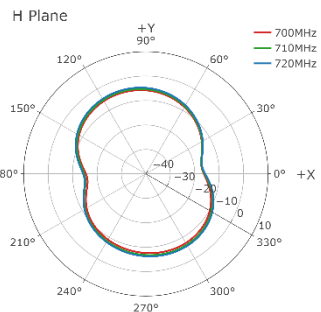
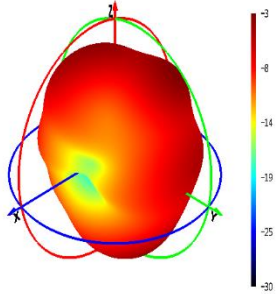
3.3.4. 3D & 2D Radiation Pattern

- Test Status: Assembled On EVB
- Test Chamber: GL-S-1

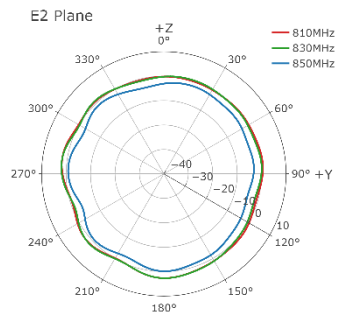
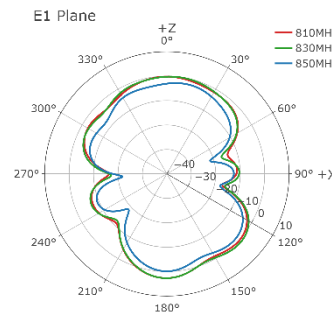
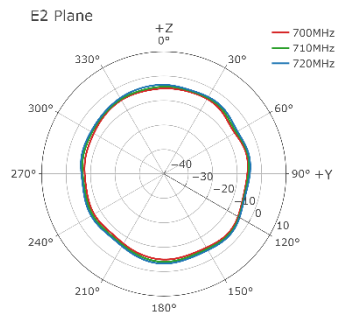
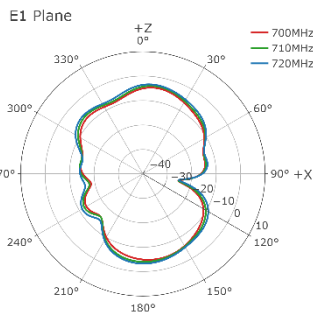
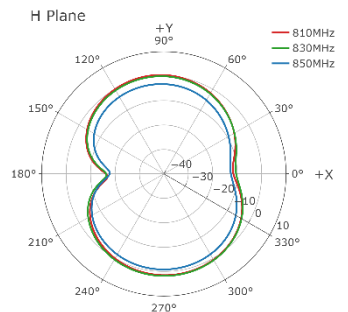
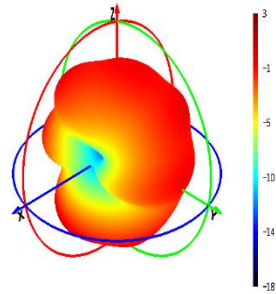


- On 140 × 36 mm EVB

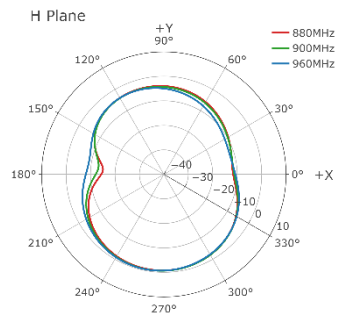
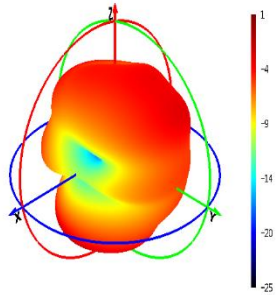
710 MHz



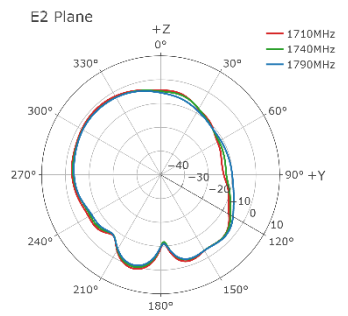
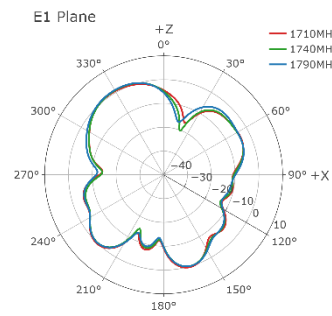
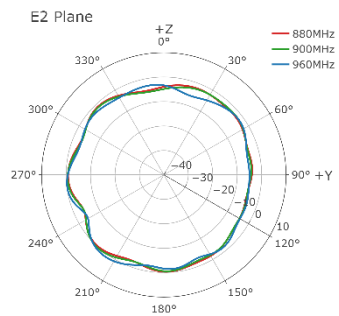
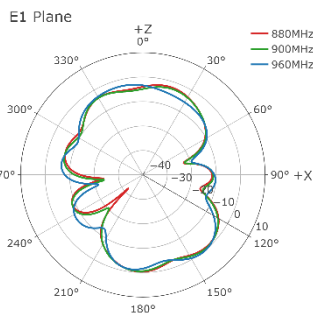
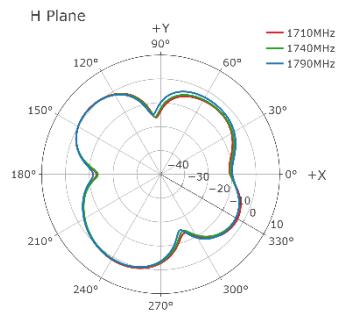
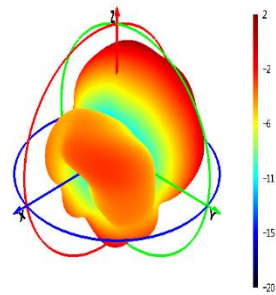
830 MHz

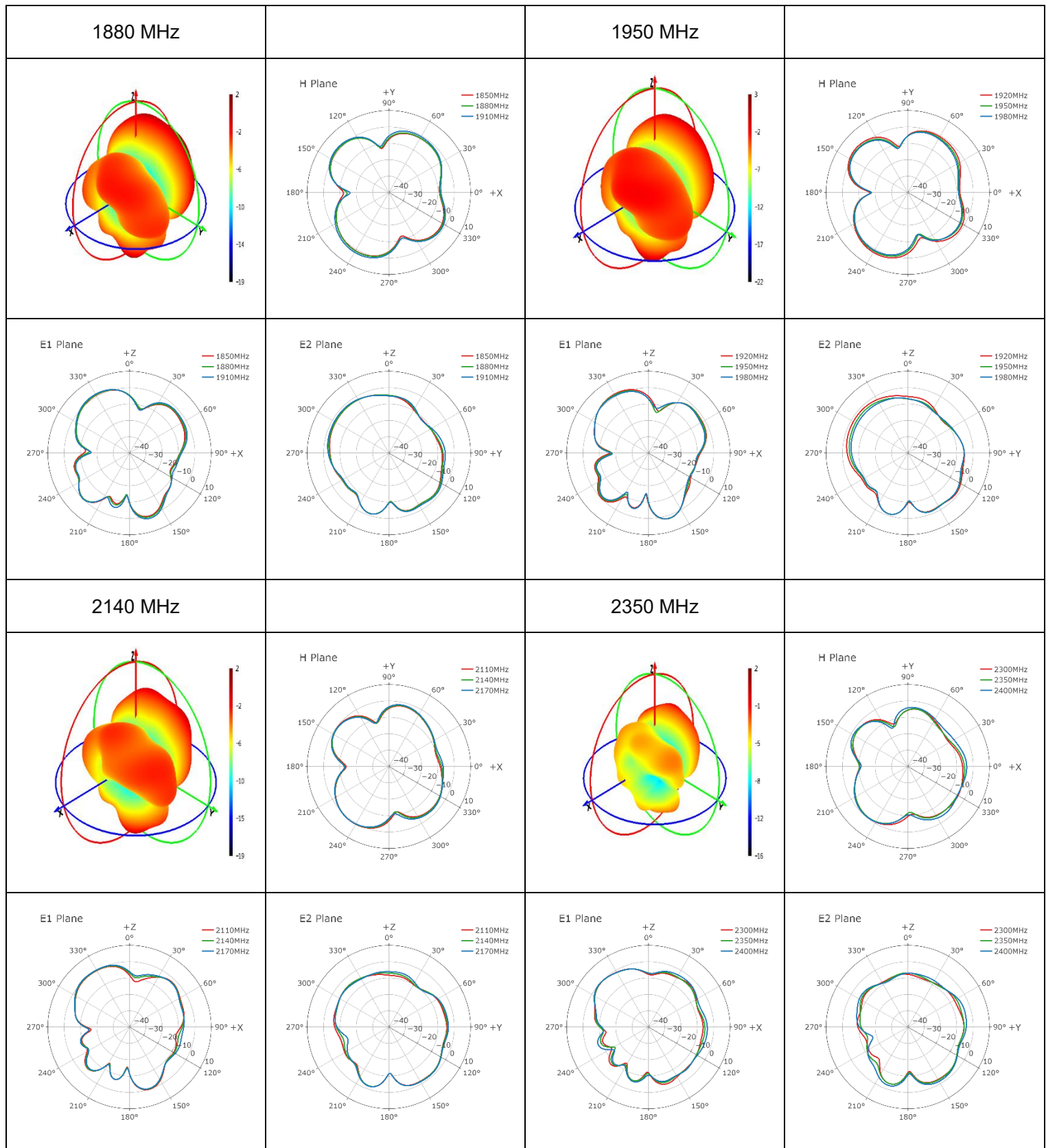


900 MHz

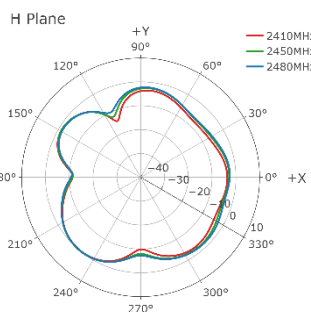
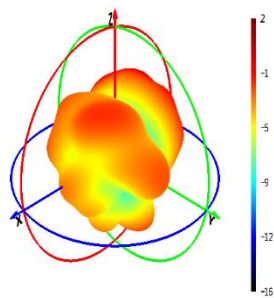


1740 MHz

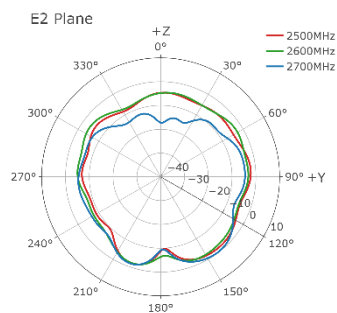
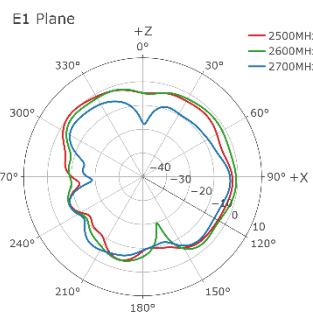
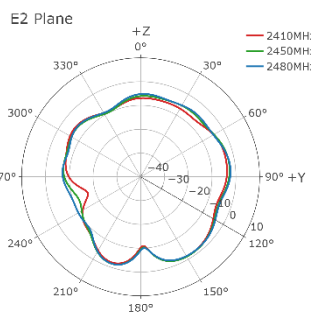
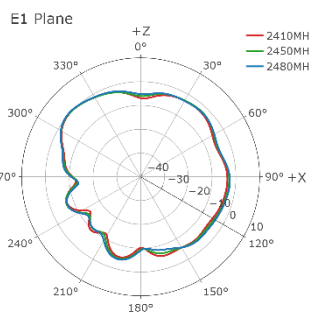
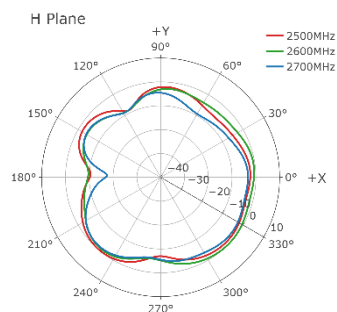
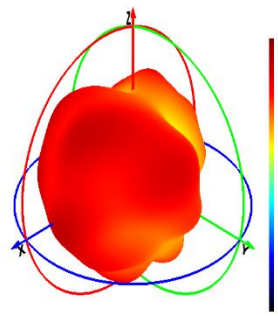




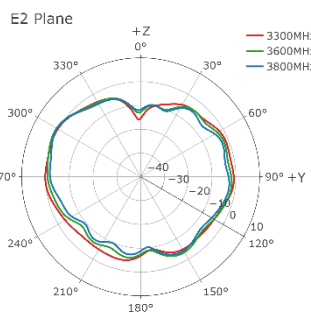
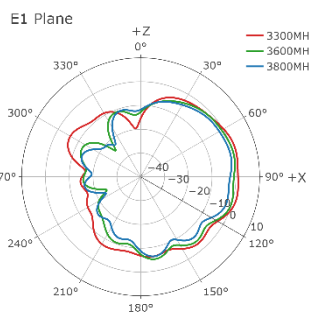
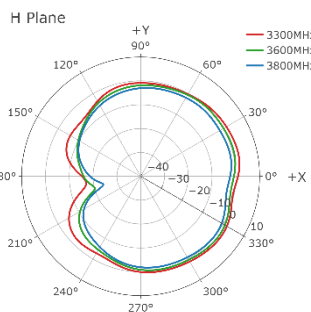
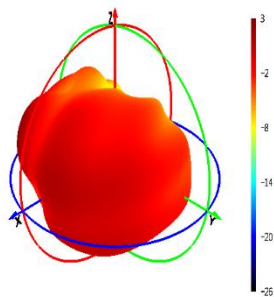
2450 MHz



2600 MHz



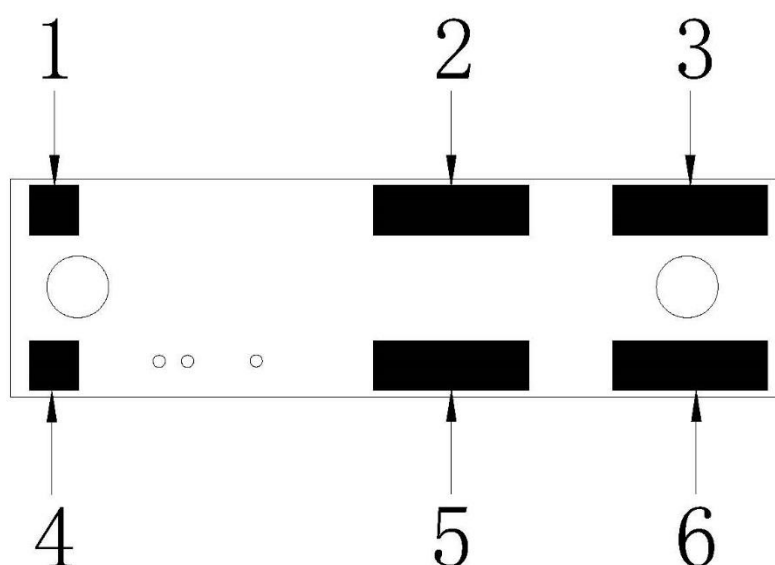
3600 MHz



4 Schematic Symbol and Pin Definition

- The pin assignment for the antenna is as follows.
- The circuit symbol for the antenna is shown below. The antenna has 6 pins, only one of which works. All other pins are for mechanical strength.

Pin	Description
1, 2, 3, 5, 6	Not used (Mechanical only)
4	Feed



5 Transmission Line

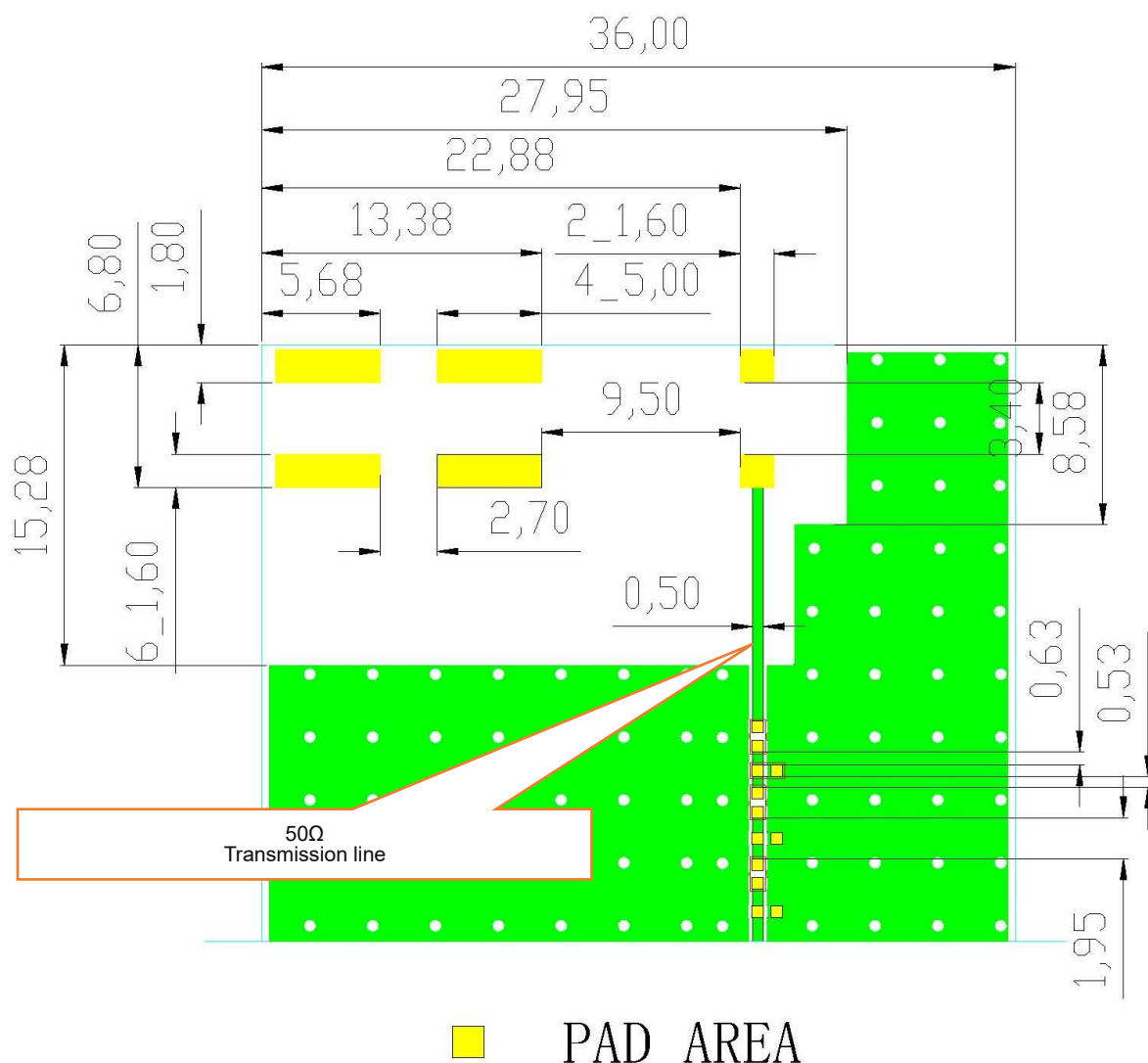
The characteristic impedance of all transmission lines shall be designed as 50 Ω .

- The length of the transmission lines should be kept as short as possible.
- Any other part of the RF system, such as transceiver, power amplifiers, etc., shall also be designed with an impedance of 50 Ω .

Once the material for the PCB has been chosen (PCB thickness and dielectric constant), a coplanar transmission line can easily be designed using any of the commercial software packages for transmission line design. For the chosen PCB thickness, copper thickness and substrate dielectric constant, the program will calculate the appropriate transmission line width and gaps on either side of the track so the characteristic impedance of the coplanar transmission is 50 Ω .

6 Recommended PCB Layout

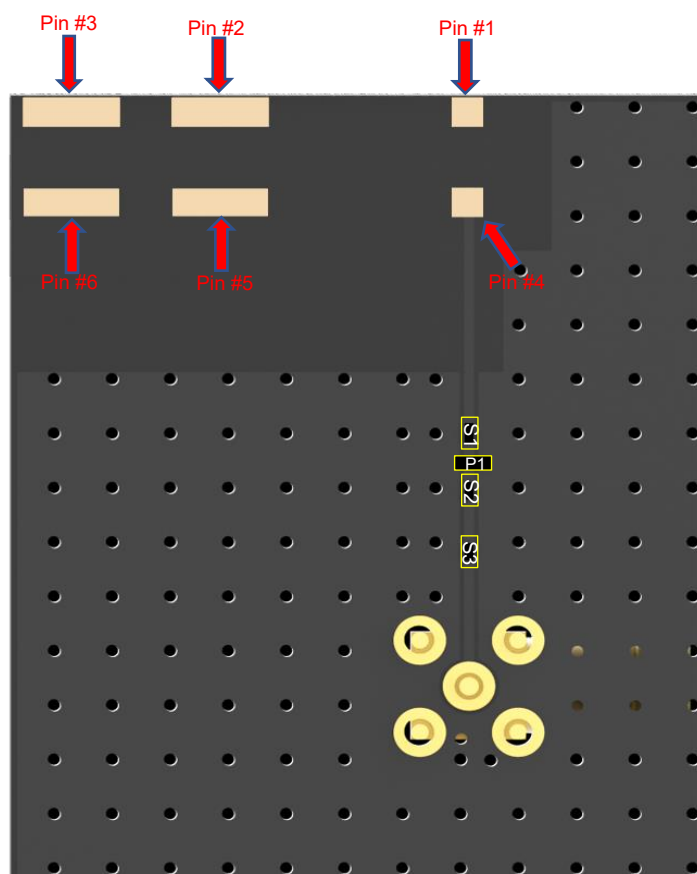
The host PCB must be designed using the PCB footprint shown with the correct clearances. An example of the PCB layout shows the antenna footprint. Please note this clearance area is critical to the performance of the antenna and must be applied through all layers of the PCB.



All dimensions are in mm.

7 Matching Circuit

Demo Board Top View



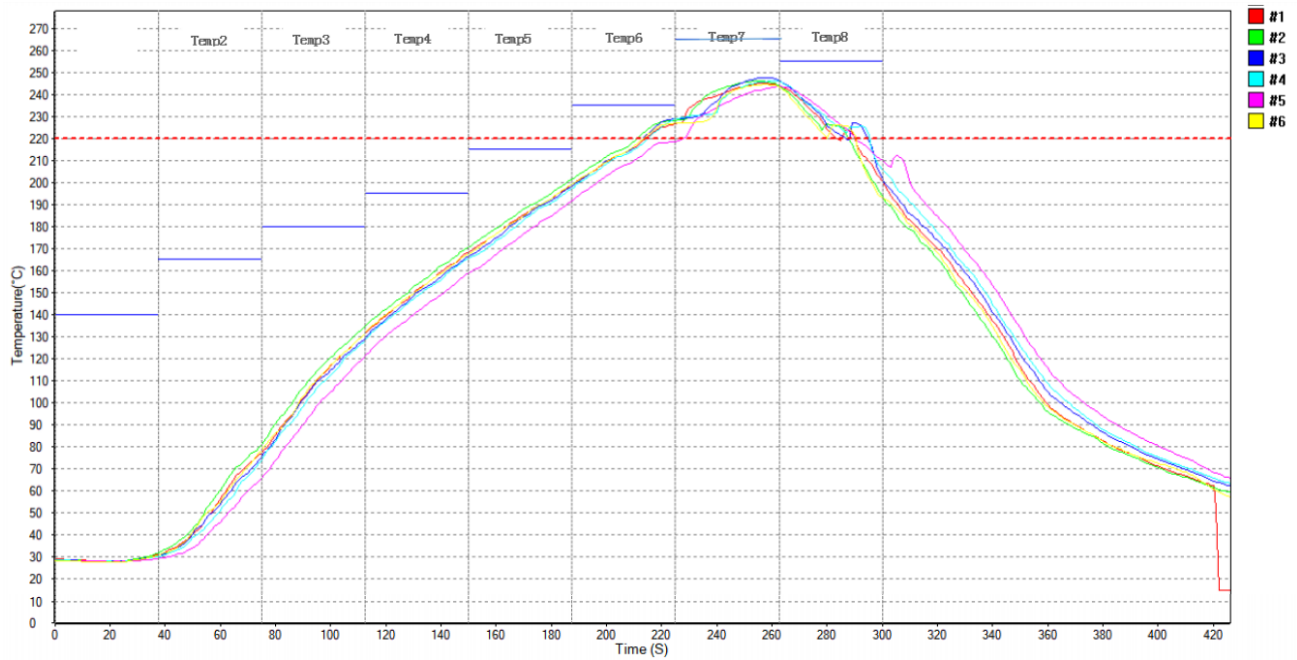
	S1	P1	S2	S3
Default Matching	0 Ohm	10 nH	2.4 pF	1.5 nH
Tolerance	-	±5 %	±5 %	±5 %

Pin #	Description
1, 2, 3, 5, 6	Not used (Mechanical only)
4	Feed

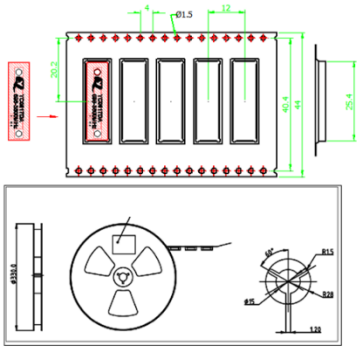
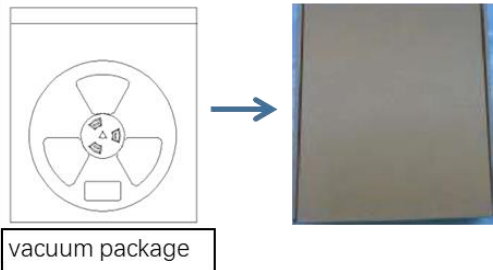
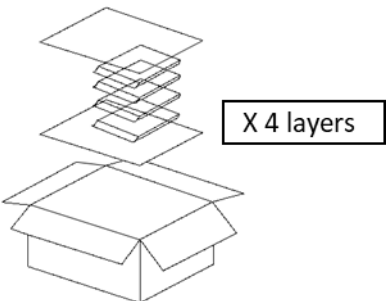
8 Soldering Temperature

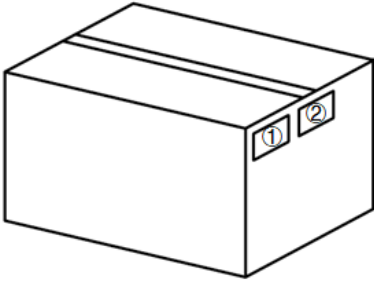
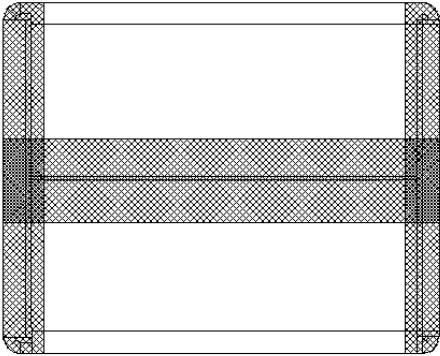
Phase	Profile Features	PB-Free Assembly
RAMP-UP	Avg. Ramp-up Rate (T _{smax} to T _p)	3 °C/second (Max.)
PREHEAT	Temperature Min (T _{smin}) Temperature Max (T _{smax}) Time (t _{smin} to t _{smax})	150 °C 190 °C 110 seconds (Max.)
REFLOW	Temperature (T _L) Total Time above T _L (t _l)	220 °C 90 seconds (Max.)
PEAK	Temperature (T _p)	230–250 °C
RAMP-DOWN	Rate	-1 °C/second (Max.)

9 Reflow Profile



10 Packaging

Step	Packaging Picture / 2D Picture	Description
1		1600 products are loaded into the carrier tape (28 spaces at the front and back). <u>Carrier Tape Size (mm): 12 × 0.3 mm</u> The carrier tape with the loaded product rolled into a plastic reel. (1600 PCS / Plastic Reel)
2		The product is packed OK in a vacuum bag and put in a pizza box. <u>Pizza Box Size (mm):</u> <u>350(L) × 350(W) × 60(H)</u>
3		Put 4 pizza boxes in a carton and place them neatly; 6400 pcs/box (estimated quantity) <u>Carton Size:</u> <u>L × W × H = 350 × 350 × 260 mm</u>

4		Position for Attaching Labels ① Carton Label ② Quality Label
5		Sealing Cartons “Ⅰ” type sealing cartons
Note	The initial packaging method described above is for reference only, and the final actual packaging method shall be subject to the actual shipping packaging.	

Contact Us

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Revision History

Version	Date	Author	Note
-	2022-12-28	Andy MIAO/ Toby WNAG	Creation of the document
1.0	2023-01-20	Andy MIAO/ Toby WNAG	First official release
1.1	2023-06-26	Toby WNAG	Updated the drawing (Chapter 5).
1.2	2023-08-04	Allow XU	Added the packaging (Chapter 7).
2.0	2023-09-07	Jaden FENG/ Toby WANG/ David LIU/ Vinnie LIU	Updated the template and all test data.
2.1	2023-12-21	Jaden FENG	Updated the PIN# (Chapter 7).
3.0	2024-03-29	Jaden FENG Vinnie LIU	Numerous changes were made to this document. It should be read in its entirety.



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